

### **MOSFET**

### OptiMOS<sup>™</sup>5 Power-Transistor, 150 V

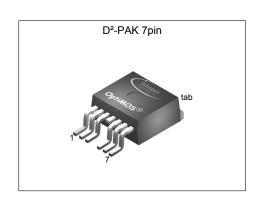
### **Features**

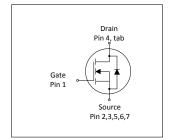
#### **Features**

- Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
  Very low reverse recovery charge (Q<sub>rr</sub>)
  175 °C operating temperature
  Pb-free lead plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target application
  Ideal for high-frequency switching and synchronous rectification
  Helegan free according to JEC61240, 2, 21
- Halogen-free according to IEC61249-2-21



Parameter	Value	Unit						
V <sub>DS</sub>	150	V						
R <sub>DS(on),max (TO263)</sub>	4.4	mΩ						
I <sub>D</sub>	174	A						
Q <sub>rr</sub>	42	nC						











Type / Ordering Code	Package	Marking	Related Links
IPB044N15N5	PG-TO263-7	044N15N5	-

### OptiMOS<sup>™</sup>5 Power-Transistor, 150 V IPB044N15N5



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### OptiMOS<sup>™</sup>5 Power-Transistor, 150 V . IPB044N15N5



## 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Davamatav	Cumbal		Values			Note / Took One distant	
Parameter	Symbol	Min.	Тур.	р. Мах.		Note / Test Condition	
Continuous drain current	I <sub>D</sub>	-	-	174 123	А	T <sub>C</sub> =25 °C T <sub>C</sub> =100 °C	
Pulsed drain current <sup>1)</sup>	I <sub>D,pulse</sub>	-	-	696	Α	<i>T</i> <sub>C</sub> =25 °C	
Avalanche energy, single pulse <sup>2)</sup>	E <sub>AS</sub>	-	-	470	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	300	W	<i>T</i> <sub>C</sub> =25 °C	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

#### 2 Thermal characteristics

Thermal characteristics Table 3

Davamatav	Values						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	0.3	0.5	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	R <sub>thJA</sub>	-	-	62	K/W	-	
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>3)</sup>	R <sub>thJA</sub>	-	-	40	K/W	-	

#### 3 **Electrical characteristics**

 Table 4
 Static characteristics

Davamatar	Cumb al		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	150	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.8	4.6	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =264 μA	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	3.4 3.7	4.4 4.8	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =87 A V <sub>GS</sub> =8 V, I <sub>D</sub> =44 A	
Gate resistance	R <sub>G</sub>	-	0.8	1.2	Ω	-	
Transconductance	<b>g</b> fs	72	144	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 87 \text{ A}$	

 $<sup>^{1)}</sup>$  See Diagram 3  $^{2)}$  See Diagram 13  $^{3)}$  Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70  $\mu m$  thick) copper area for drain connection. PCB is vertical in still air.

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**Table 5** Dynamic characteristics

Damamatan	Complete	Values			I I m i 4	Nata / Tast Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	6000	8000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	1500	2000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, f=1 MHz	
Reverse transfer capacitance <sup>1)</sup>	Crss	-	34	60	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	19	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =87 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Rise time	t <sub>r</sub>	-	6	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =87 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	24	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =87 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Fall time	t <sub>f</sub>	-	5.0	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =87 A, $R_{\rm G,ext}$ =1.6 $\Omega$	

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Cross bod		Values		I I mit	Note / Took Condition	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	34	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =87 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge <sup>1)</sup>	$Q_{\rm gd}$	-	16	24	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =87 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	27	-	nC	$V_{DD}$ =75 V, $I_{D}$ =87 A, $V_{GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	Qg	-	80	100	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =87 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	5.6	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =87 A, $V_{\rm GS}$ =0 to 10 V	
Output charge <sup>1)</sup>	Qoss	-	225	299	nC	V <sub>DD</sub> =75 V, V <sub>GS</sub> =0 V	

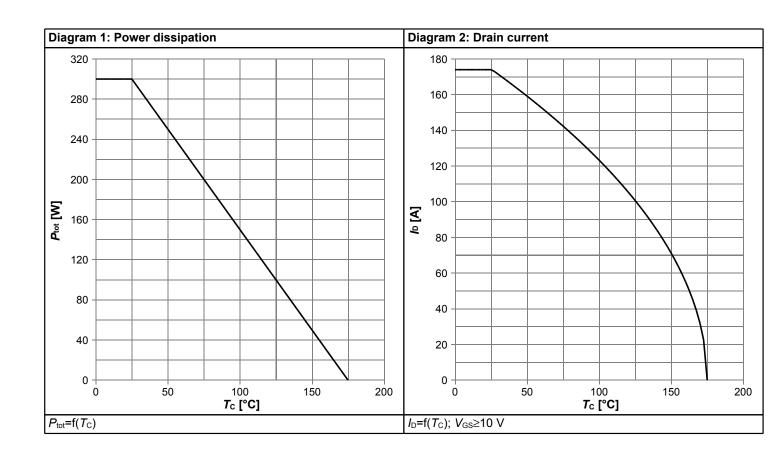
### Table 7 Reverse diode

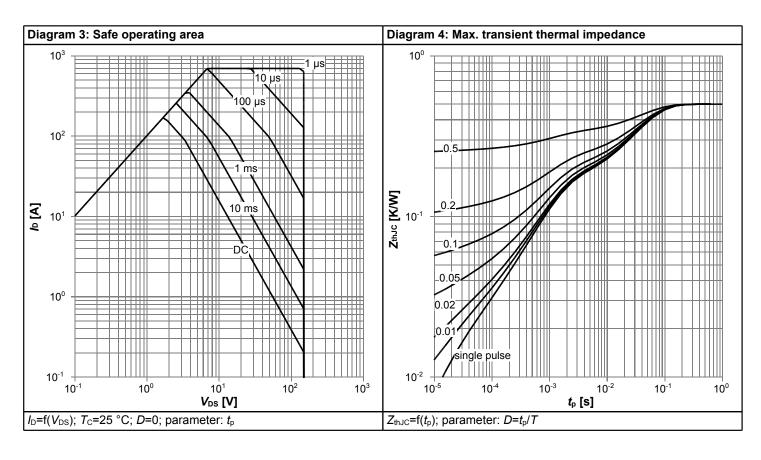
Davamatar	Cumbal		Values	}	l lmi4	Note / Took Condition	
Parameter	Symbol	Min.			Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	174	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	696	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.86	1.1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =87 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	43	86	ns	V <sub>R</sub> =75 V, I <sub>F</sub> =87, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	42	84	nC	V <sub>R</sub> =75 V, I <sub>F</sub> =87, di <sub>F</sub> /dt=100 A/μs	

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test  $^{2)}$  See "Gate charge waveforms" for parameter definition

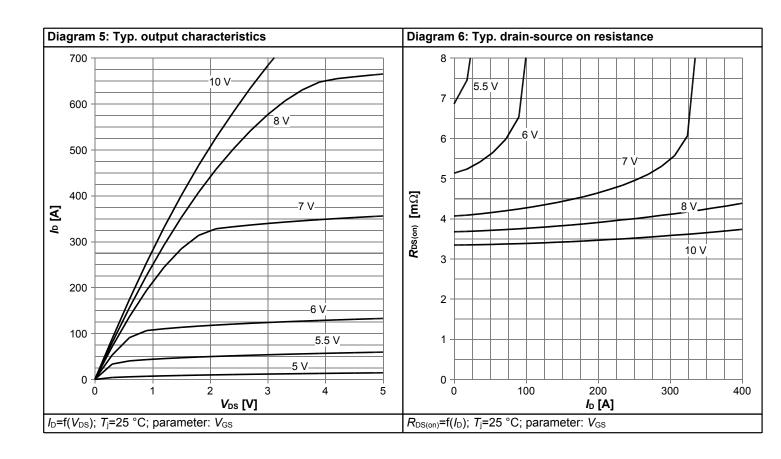


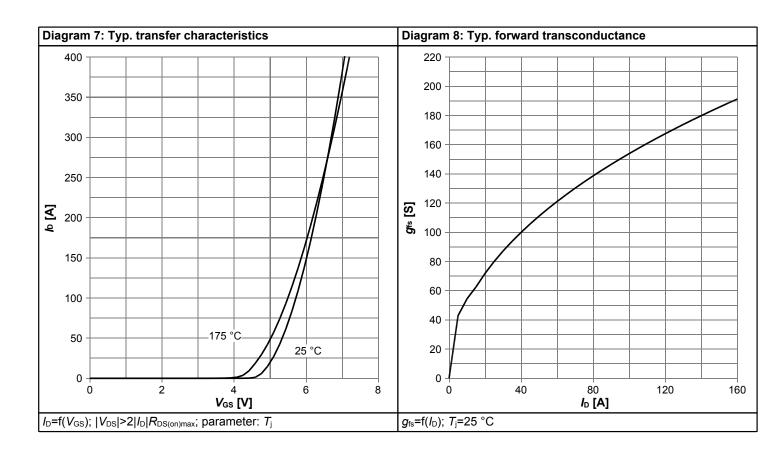
### 4 Electrical characteristics diagrams



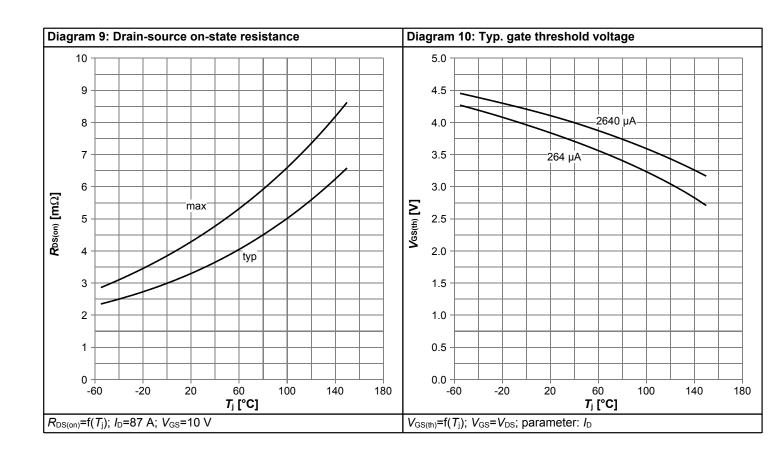


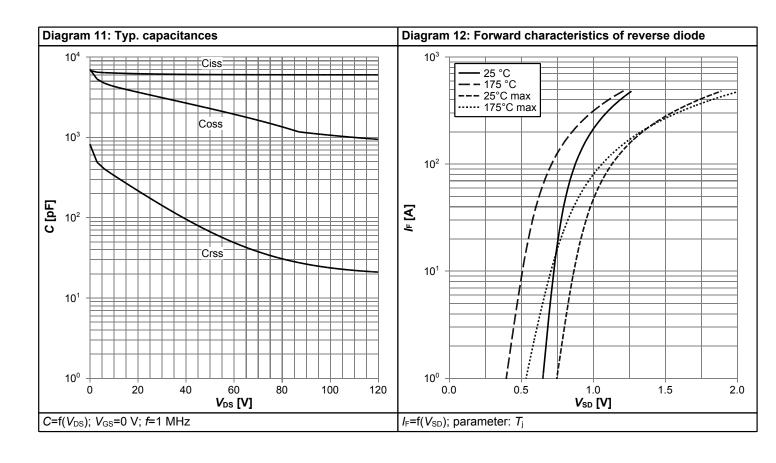




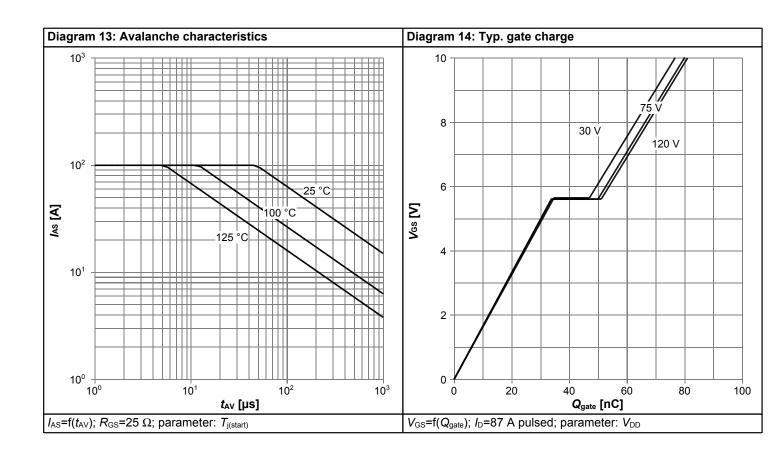


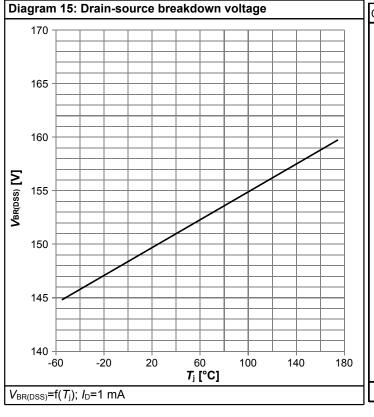


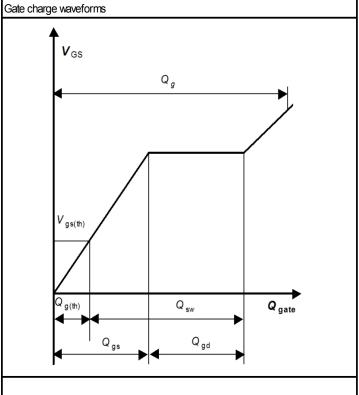






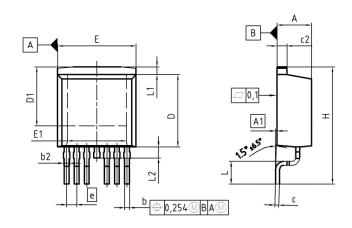


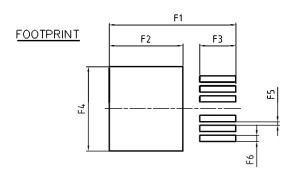






### 5 Package Outlines





DIM	DIM MILLIMETERS		INC	HES		
DIM	MIN	MAX	MIN	MAX		
Α	4.30	4.57	0.169	0.180		
A1	0.00	0.25	0.000	0.010		
Ь	0.50	0.70	0.020	0.028		
b2	0.50	1.00	0.020	0.039		
С	0.33	0.65	0.013	0.026		
c2	1.17	1.40	0.046	0.055		
D	8.51	9.45	0.335	0.372		
D1	6.90	7.90	0.272	0.311		
E	9.80	10.31	0.386	0.406		
E1	6.50	8.60	0.256	0.339		
е	1.	1.27		0.050		
N		6		6		
Н	14.61	15.88	0.575	0.625		
L	2.29	3.00	0.090	0.118		
L1	0.70	1.60	0.028	0.063		
L2	1.00	1.78	0.039	0.070		
F1	16.05	16.25	0.632	0.640		
F2	9,30	9.50	0.366	0.374		
F3	4.50	4.70	0.177	0.185		
F4	10.70	10.90	0.421	0.429		
F5	0.37	0.57	0.015	0.022		
F6	0.70	0.90	0.028	0.035		

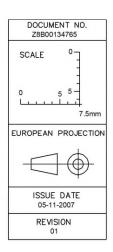


Figure 1 Outline PG-TO263-7, dimensions in mm/inches

### OptiMOS<sup>™</sup>5 Power-Transistor, 150 V IPB044N15N5



### **Revision History**

IPB044N15N5

Revision: 2016-04-06

Previous Pavision

Previous Revision				
Date	Date Subjects (major changes since last revision)			
2016-04-06	Release of final version			

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